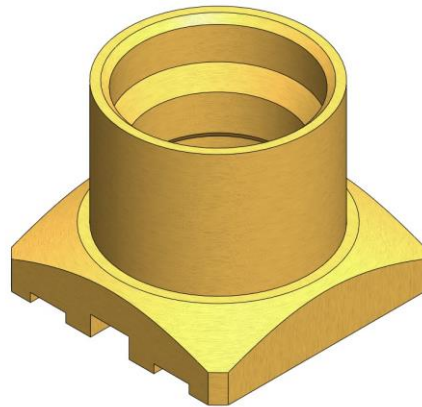




Project Number: Design Qualification Test Report	Tracking Code: CR-918203_Report_Rev_1
Requested by: Joe Huang	Date: 9/1/2023
Part #: SMP-PL-P-HG-ST-SM	Tech: Peter Chen
Part description: SMP Surface Mount Connector	Qty to test: 20
Test Start: 5/4/2023	Test Completed: 5/25/2023



DESIGN QUALIFICATION TEST REPORT

**SMP Surface Mount Connector
SMP-PL-P-HG-ST-SM**

Tracking Code: CR-918203_Report_Rev_1	Part #: SMP-PL-P-HG-ST-SM
Part description: SMP Surface Mount Connector	

REVISION HISTORY

DATA	REV.NUM.	DESCRIPTION	ENG
6/21/2023	1	Initial Issue	PC

CERTIFICATION

All instruments and measuring equipment were calibrated to National Institute for Standards and Technology (NIST) traceable standards according to ISO 10012-1 and ANSI/NCSL 2540-1, as applicable.

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SCOPE

To perform the following tests: Design Qualification test. Please see test plan.

APPLICABLE DOCUMENTS

Standards: MIL-PRF-39012 and EIA-364.

TEST SAMPLES AND PREPARATION

- 1) All materials were manufactured in accordance with the applicable product specification.
- 2) All test samples were identified and encoded to maintain traceability throughout the test sequences.
- 3) After soldering, the parts to be used for LLCR and IR_DWV testing were cleaned according to TLWI-0001.
- 4) Either an automated cleaning procedure or an ultrasonic cleaning procedure may be used.
- 5) The automated procedure is used with aqueous compatible soldering materials.
- 6) Parts not intended for testing LLCR and IR_DWV are visually inspected and cleaned if necessary.
- 7) Any additional preparation will be noted in the individual test sequences.
- 8) Solder Information: Lead Free

FLOWCHARTS**IR/DWV***Note: CONNECTORS TESTED AFTER SOLDERED TO BOARD***Pin-to-Ground**Group 1

SMP-PL-P-HG-ST-SM
 RF405-00SJ7-505050-0305
 2 Assemblies

Step	Description
1.	DWV Breakdown (2) - Non Standard

Group 2

SMP-PL-P-HG-ST-SM
 RF405-00SJ7-505050-0305
 8 Assemblies

Step	Description
1.	IR (3) - Non Standard
2.	DWV at Test Voltage ⁽¹⁾ - Non Standard Test Voltage = 500 V
3.	Thermal Shock (4) - Non Standard
4.	IR (3) - Non Standard
5.	DWV at Test Voltage ⁽¹⁾ - Non Standard Test Voltage = 500 V

-
- (1) DWV at Test Voltage = Other
500 Vrms min. at sea level per DSCC 94008
DWV test voltage is equal to 75% of the lowest breakdown voltage
Test voltage applied for 60 seconds per DSCC-94008
- (2) DWV Breakdown = Other
Record breakdown voltage. (Data only)
- (3) IR = Other
5000 megohms min per DSCC 94008
MIL-PRF-39012
- (4) Thermal Shock = Other
MIL-STD-202-107
Test condition B per DSCC 94008. Exception - high temperature to be +165°C. Visual inspection for damage.

FLOWCHARTS Continued**Mechanical Shock/Random Vibration/Event Detection**Group 1

SMP-PL-P-HG-ST-SM

RF405-00SJ7-505050-0305

8 Assemblies

*Note: CONNECTORS TESTED AFTER
SOLDERED TO BOARD*

Step Description

1. LLCR (1) - Non Standard
Note: Signal and ground
2. Mechanical Shock
*Note: MIL-STD-202, Method 213,
Test Condition I. EXCEPTION - 50
ns max. electrical interruption.*
3. Nanosecond Event Detection
(Mechanical Shock) (2) - Non Standard
4. High Frequency Vibration
*Note: MIL-STD-202 Method 204,
Test Condition D(20g peak) per
DSCC 94008. EXCPETION - 50 ns
max. electrical interruption.*
5. Nanosecond Event Detection
(Random Vibration) (3) - Non Standard
6. LLCR (1) - Non Standard
MAX DELTA = 15 mOhm
Note: Signal and ground

(1) LLCR = EIA-364-23

Open Circuit Voltage = 20 mV Max
Test Current = 100 mA Max

(2) Nanosecond Event Detection (Mechanical Shock) = Other

Test condition I per DSCC 94008 (100g). EXCEPTION: 50 ns max. electrical interruption.
MIL-STD-202-213

(3) Nanosecond Event Detection (Random Vibration) = Other

Test condition D(20g peak) per DSCC 94008(15 minutes min.). EXCEPTION - 50 ns max. electrical interruption.
MIL-STD-202 Method 204

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Part description: SMP Surface Mount Connector	

FLOWCHARTS Continued

Pull/Shear

Note: CONNECTORS TESTED AFTER SOLDERED TO BOARD. USE TEST BOARD FROM PREVIOUS TESTS

Group 1
SMP-PL-P-HG-ST-SM

5 Assemblies

Group 2
SMP-PL-P-HG-ST-SM

5 Assemblies

Step	Description
1.	Connector Pull <i>Note: PULL TO DESTRICT, AXIALLY AWAY FROM BOARD. Record failure force (data only).</i>

Step	Description
1.	Connector Shear <i>Note: SHEAR TO DESTRICT, PARALLEL TO BOARD. Record failure force (data only).</i>

ATTRIBUTE DEFINITIONS

The following is a brief, simplified description of attributes.

THERMAL SHOCK:

- 1) MIL-PRF-39012, *Paragraph. 4.6.17 per MIL-STD-202-107*
- 2) Test Condition: I (-65°C to +165°C)
- 3) Test Time: ½ hour dwell at each temperature extreme
- 4) Test Duration: Test condition B except 10 cycles instead of 5.
- 5) All test samples are pre-conditioned at ambient.
- 6) All test samples are exposed to environmental stressing in the mated condition.

LLCR:

- 1) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets.*
- 2) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 3) The following guidelines are used to categorize the changes in LLCR as a result from stressing
 - a. $\leq +5.0$ mOhms: -----Stable
 - b. $+5.1$ to $+10.0$ mOhms:-----Minor
 - c. $+10.1$ to $+15.0$ mOhms: -----Acceptable
 - d. $+15.1$ to $+50.0$ mOhms: -----Marginal
 - e. $+50.1$ to $+1000$ mOhms: -----Unstable
 - f. $>+1000$ mOhms:-----Open Failure

MECHANICAL SHOCK (Specified Pulse):

- 1) Reference document: MIL-STD-202, Method 213 Cond. I.
- 2) Test Condition G
- 3) Peak Value: 100 G
- 4) Duration: 6 Milliseconds
- 5) Wave Form: Sawtooth
- 6) Velocity: 12.3 ft/s
- 7) Number of Shocks: 3 Shocks / Direction, 3 Axis (18 Total)

VIBRATION:

- 1) Reference document: MIL-STD-202-204, Condition D.
- 2) Test Condition V, Letter B
- 3) Power Spectral Density: $0.10 G^2 / Hz$
- 4) G 'RMS': 7.56
- 5) Frequency: 50 to 2000 Hz
- 6) Duration: 2.0 Hours per axis (3 axis total)

NANOSECOND-EVENT DETECTION:

- 1) Reference document: MIL-STD-202, *Nanosecond-Event Detection for Electrical Connectors*
- 2) Prior to test, the samples were characterized to assure the low nanosecond event being monitored will trigger the detector.
- 3) After characterization it was determined the test samples could be monitored for 50 nanosecond events

ATTRIBUTE DEFINITIONS Continued

The following is a brief, simplified description of attributes

INSULATION RESISTANCE (IR):

To determine the resistance of insulation materials to leakage of current through or on the surface of these materials when a DC potential is applied.

- 1) PROCEDURE:
 - a. Reference document: MIL-PRF-39012, *Insulation Resistance Test Procedure for Electrical Connectors*.
 - b. Test Conditions:
 - i. Between Adjacent Contacts or Signal-to-Ground
 - ii. Electrification Time 2.0 minutes
 - iii. Test Voltage (500 VDC) corresponds to calibration settings for measuring resistances.
- 2) MEASUREMENTS:
- 3) When the specified test voltage is applied (VDC), the insulation resistance shall not be less than 5000 megohms.

DIELECTRIC WITHSTANDING VOLTAGE (DWV):

To determine if the sockets can operate at its rated voltage and withstand momentary over potentials due to switching, surges, and other similar phenomenon. Separate samples are used to evaluate the effect of environmental stresses so not to influence the readings from arcing that occurs during the measurement process.

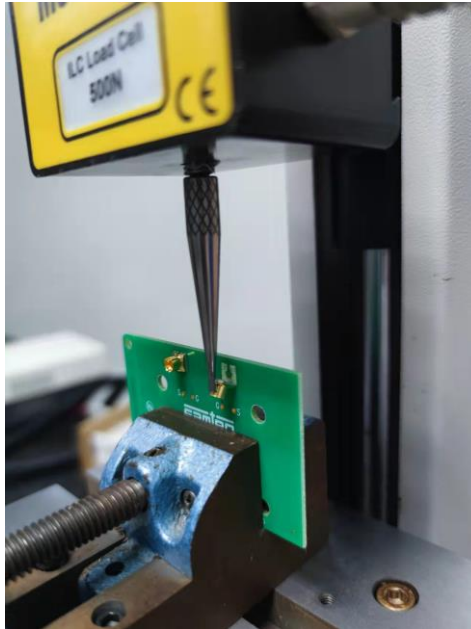
- 1) PROCEDURE:
 - a. Reference document: MIL-PRF-39012, *Withstanding Voltage Test Procedure for Electrical Connectors*.
 - b. Test Conditions:
 - i. Between Adjacent Contacts or Signal-to-Ground
 - ii. Barometric Test Condition 1
 - iii. Rate of Application 500 V/Sec
 - iv. Test Voltage (VAC) until breakdown occurs
- 2) MEASUREMENTS/CALCULATIONS
 - a. The breakdown voltage shall be measured and recorded.
 - b. The dielectric withstanding voltage shall be recorded as 75% of the minimum breakdown voltage.
 - c. The working voltage shall be recorded as one-third (1/3) of the dielectric withstanding voltage (one-fourth of the breakdown voltage).

ATTRIBUTE DEFINITIONS Continued

The following is a brief, simplified description of attributes

Pull/Shear

Pull to destruct, Axially away from board and parallel to board, record failure force.



parallel to board



Axially away from board

RESULTS**Pull/Shear**

- **Axially**
 - **Min** -----15.14 Lbs
 - **Max** -----22.54 Lbs
- **Parallel**
 - **Min** -----54.92 Lbs
 - **Max** -----60.52 Lbs

Insulation Resistance minimums, IR**Pin to Ground**

- **Initial**
 - **Mated** -----45000 Meg Ω ----- Passed
- **Thermal Shock**
 - **Mated** -----45000 Meg Ω ----- Passed

Dielectric Withstanding Voltage minimums, DWV

- **Minimums**
 - **Breakdown Voltage** ----- 1386 VAC
 - **Test Voltage** ----- 1040 VAC
 - **Working Voltage** -----345 VAC

Pin to Ground

- **Initial DWV** -----Passed
- **Thermal DWV** -----Passed

RESULTS Continued

LLCR Shock & Vibration (16 LLCR test points)

Signal pin

- Initial ----- 30.99 mOhms Max

Ground Pin

- Initial -----4.34 mOhms Max
- Shock &Vibration
 - <= +5.0 mOhms----- 16 Points ----- Stable
 - +5.1 to +10.0 mOhms -----0 Points ----- Minor
 - +10.1 to +15.0 mOhms -----0 Points ----- Acceptable
 - +15.1 to +50.0 mOhms -----0 Points ----- Marginal
 - +50.1 to +1000 mOhms-----0 Points ----- Unstable
 - >+1000 mOhms -----0 Points ----- Open Failure

Mechanical Shock & Random Vibration:

- Shock
 - No Damage----- Pass
 - 50 Nanoseconds ----- Pass
- Vibration
 - No Damage----- Pass
 - 50 Nanoseconds ----- Pass

DATA SUMMARIES**Pull/Shear:****Axially**

	Force (lbs)
Minimum	15.14
Maximum	22.54
Average	18.75

Parallel

	Force (lbs)
Minimum	54.92
Maximum	60.52
Average	58.10

INSULATION RESISTANCE (IR):

	Pin to Ground		
	Mated	Unmated	Unmated
Minimum	SMP/RF405	SMP	RF405
Initial	45000	45000	45000
Thermal	45000	45000	45000

DIELECTRIC WITHSTANDING VOLTAGE (DWV):

Voltage Rating Summary	
Minimum	SMP/RF405
Break Down Voltage	1386
Test Voltage	1040
Working Voltage	345

Pin to Ground	
Initial Test Voltage	Passed
After Thermal Test Voltage	Passed

DATA SUMMARIES Continued

LLCR Shock &Vibration:

- 1). A total of 16 points were measured.
- 2). EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets.*
- 3). The following guidelines are used to categorize the changes in LLCR as a result from stressing.
 - a. $\leq +5.0$ mOhms: -----Stable
 - b. $+5.1$ to $+10.0$ mOhms: -----Minor
 - c. $+10.1$ to $+15.0$ mOhms: -----Acceptable
 - d. $+15.1$ to $+50.0$ mOhms: -----Marginal
 - e. $+50.1$ to $+1000$ mOhms -----Unstable
 - f. $>+1000$ mOhms:-----Open Failure

LLCR Measurement Summaries by Pin Type			
Date	5/18/2023	5/24/2023	
Room Temp (Deg C)	22	22	
Rel Humidity (%)	42	46	
Technician	Tony Wagoner	Tony Wagoner	
mOhm values	Actual	Delta	
	Initial	Shock-Vib	
Pin Type: Signal 1			
Average	30.57	1.52	
St. Dev.	0.38	0.64	
Min	29.91	0.35	
Max	30.99	2.2	
Summary Count	8	8	
Total Count	8	8	
Pin Type: GND 1			
Average	4.25	0.9	
St. Dev.	0.07	0.16	
Min	4.14	0.63	
Max	4.34	1.1	
Summary Count	8	8	
Total Count	8	8	

LLCR Delta Count by Category						
	Stable	Minor	Acceptable	Marginal	Unstable	Open
mOhms	≤ 5	$>5 \ \& \ \leq 10$	$>10 \ \& \ \leq 15$	$>15 \ \& \ \leq 50$	$>50 \ \& \ \leq 1000$	>1000
Shock-Vib	16	0	0	0	0	0

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Part description: SMP Surface Mount Connector	

DATA SUMMARIES Continued

Nanosecond Event Detection:

Shock and Vibration Event Detection Summary	
Contacts tested	16
Test Condition	MIL-STD-202, Method 213 Cond. I
Shock Events	0
Test Condition	MIL-STD-202-204, Condition D
Vibration Events	0
Total Events	0

EQUIPMENT AND CALIBRATION SCHEDULES**Equipment #:** HZ-TCT-04**Description:** Dillon Quantrol TC21 25-1000 mm/min series test stand**Manufacturer:** Dillon Quantrol**Model:** TC2 I series test stand**Serial #:** 04-1041-04**Accuracy:** Speed Accuracy: +/- 5% of indicated speed; Speed Accuracy: +/- 5% of indicated speed;
... Last Cal: 05/29/2023, Next Cal: 05/29/2024**Equipment #:** HZ-TSC-01**Description:** Vertical Thermal Shock Chamber**Manufacturer:** Cincinnati Sub Zero**Model:** VTS-3-6-6-SC/AC**Serial #:** 10-VT14993**Accuracy:** See Manual

... Last Cal: 06/30/2022, Next Cal: 06/30/2023

Equipment #: HZ-HPT-01**Description:** Hipot Safety Tester**Manufacturer:** Vitrek**Model:** V73**Serial #:** 019808**Accuracy:**

... Last Cal: 05/15/2023, Next Cal: 05/15/2024

Equipment #: SVC-01**Description:** Shock & Vibration Table**Manufacturer:** Data Physics**Model:** LE-DSA-10-20K**Serial #:** 10037**Accuracy:** See Manual

... Last Cal: 11/31/2022, Next Cal: 11/31/2023

Equipment #: ACLM-01**Description:** Accelerometer**Manufacturer:** PCB Piezotronics**Model:** 352C03**Serial #:** 115819**Accuracy:** See Manual

... Last Cal: 07/09/2022, Next Cal: 07/09/2023

Equipment #: ED-03**Description:** Event Detector**Manufacturer:** Analysis Tech**Model:** 32EHD**Serial #:** 1100604**Accuracy:** See Manual

... Last Cal: 06/04/2023, Next Cal: 06/04/2024